



DP0150ALP4 / DP0150BLP4

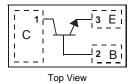
PNP SMALL SIGNAL SURFACE MOUNT TRANSISTOR

Features

- Epitaxial Die Construction
- Ultra-Small Leadless Surface Mount Package
- Ultra-low Profile (0.40mm max)
- Complementary NPN Type Available (DN0150ALP4 / DN0150BLP4)
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q 101 Standards for High Reliability

Mechanical Data

- Case: DFN1006H4-3
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections Indicator: Collector Dot
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Ordering Information: See Page 3
- Marking Information: See Page 3
- Weight: 0.0008 grams (approximate)



Device Schematic

Bottom View

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Maximum Ratings $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-50	V
Collector-Emitter Voltage	V _{CEO}	-50	V
Emitter-Base Voltage	V _{EBO}	-5	V
Collector Current - Continuous	Ι _C	-100	mA
Peak Pulse Collector Current	I _{CM}	-200	mA
Base Current	IB	-30	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3)	PD	450	mW
Thermal Resistance, Junction to Ambient (Note 3)	$R_{ ext{ heta}JA}$	278	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS							
Collector-Base Breakdown Voltage		V(BR)CBO	-50	—		V	$I_{C} = -10 \mu A$, $I_{E} = 0$
Collector-Emitter Breakdown Voltage (Note 4)		V(BR)CEO	-50	—	-	V	$I_{\rm C} = -1 {\rm mA}, I_{\rm B} = 0$
Emitter-Base Breakdown Voltage		V(BR)EBO	-5	—	-	V	$I_E = -10\mu A$, $I_C = 0$
Collector Cut-Off Current		I _{CBO}	—	—	-0.1	μΑ	$V_{CB} = -50V, I_E = 0$
Emitter Cut-Off Current		I _{EBO}	—	—	-0.1	μΑ	$V_{EB} = -5V, I_{C} = 0$
ON CHARACTERISTICS (Note 4)							
Collector-Emitter Saturation Voltage		V _{CE(SAT)}	_	-0.15	-0.3	V	I _C = -100mA, I _B = -10mA
DC Current Gain	DP01510ALP4	P4 .	120	—	240		$V_{CE} = -6V, I_{C} = -2mA$
	DP01510BLP4	h _{FE}	200		400		$V_{CE} = -6V, I_{C} = -211A$
SMALL SIGNAL CHARACTERISTICS	6			-			
Transition Frequency		f _T	80	—	_	MHz	$V_{CE} = -10V$, $I_E = 1mA$ f = 30MHz
Output Capactiance		C _{ob}	_	1.6	_	pF	$V_{CB} = -10V, I_E = 0,$ f = 1MHz

Notes: 1. No purposefully added lead.

2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

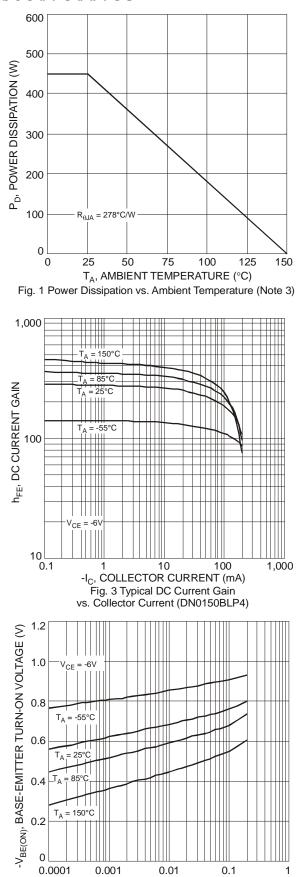
3. Device mounted on FR-4 PCB with minimum recommended pad layout.

4. Measured under pulsed conditions. Pulse width = 300 μ s. Duty cycle \leq 2%

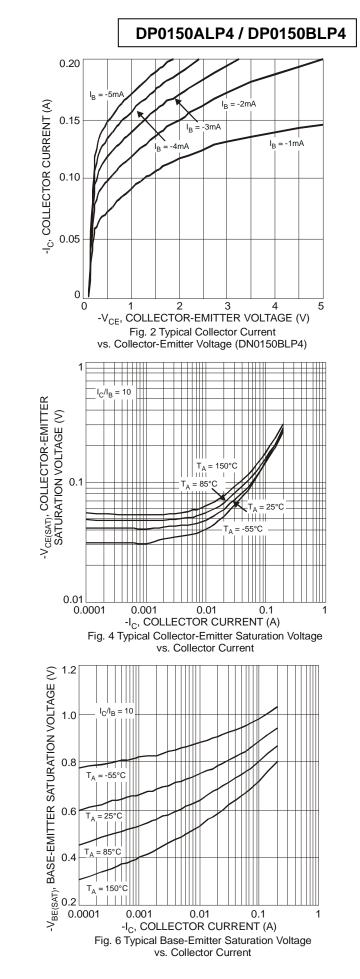


EW PRODUCT

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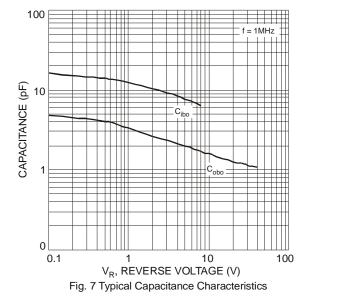


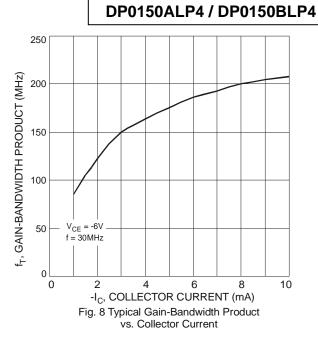
-I_C, COLLECTOR CURRENT (A) Fig. 5 Typical Base-Emitter Turn-On Voltage vs. Collector Current



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Ordering Information (Note 5)

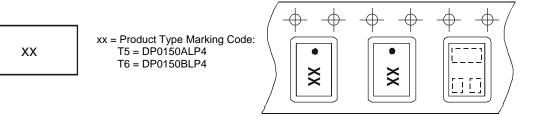
Part Number	Case	Packaging
DP0150ALP4-7	DFN1006H4-3	3000/Tape & Reel
DP0150BLP4-7	DFN1006H4-3	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information

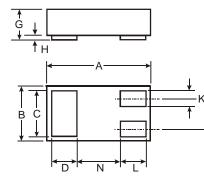
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DFN1006H4-3 Taping orientation



Direction of feed

Package Outline Dimensions

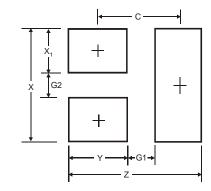


DFN1006H4-3				
Dim	Min	Max	Тур	
Α	0.95	1.075	1.00	
в	0.55	0.675	0.60	
С	0.45	0.55	0.50	
D	0.20	0.30	0.25	
G		0.40	_	
Н	0	0.05	0.02	
κ	0.10	0.20	0.15	
1	0.20	0.30	0.25	
Μ		_	0.35	
Ν	_	_	0.40	
All Dimensions in mm				

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Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.1
G1	0.3
G2	0.2
Х	0.7
X1	0.25
Y	0.4
C	0.7

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